



September 10th, 2026 | Abhishek Shendre, Nagesh Shirali and Aki Fujimura

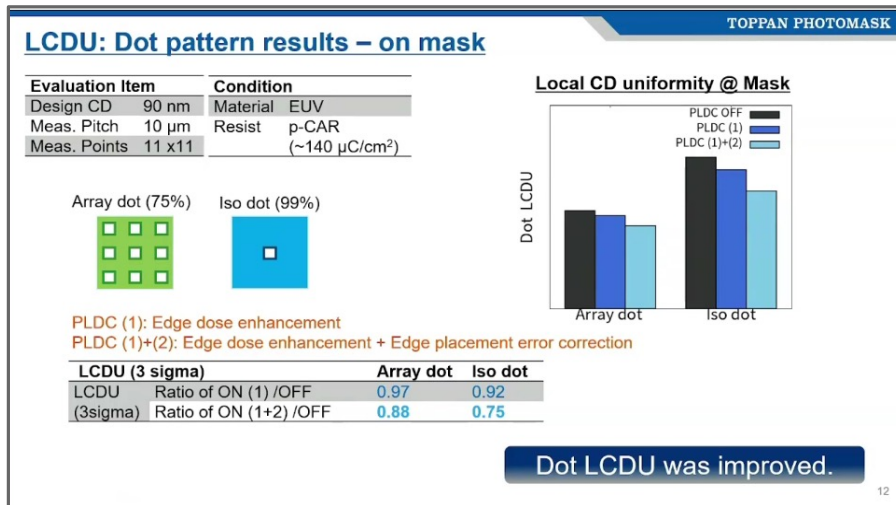
Reduce PEC squishing to improve LCDU and GCDU with no impact on mask write times

D2S Patented Technology. Confidential & Proprietary • D2S® and TrueMask® are US-registered trademarks of D2S, Inc. in US.
TrueMask® and TrueModel® are registered trademarks of D2S, Inc. in US, Japan, Korea, China and Taiwan.

Mask Uniformity is As Important As Linearity

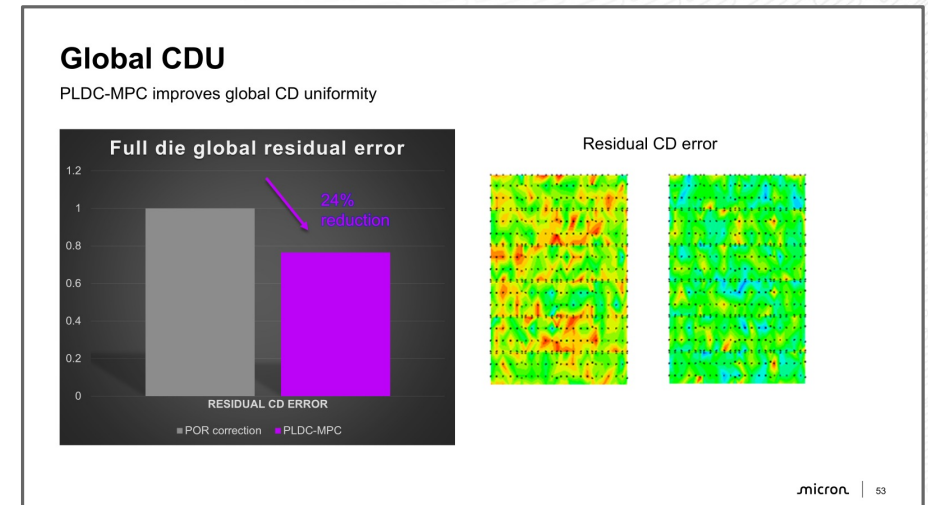
Every variation on mask is a systematic variation on wafer

BACUS 2024 by Tekscend



Mayuko Matsumoto, Naoki Yoshida, Tetsunori Hirata, et al. "Mask performance improvement by pixel level dose correction", Proc. SPIE 13216, Photomask Technology 2024, 132160H (12 Nov 2024); <https://doi.org/10.1117/12.3034611>

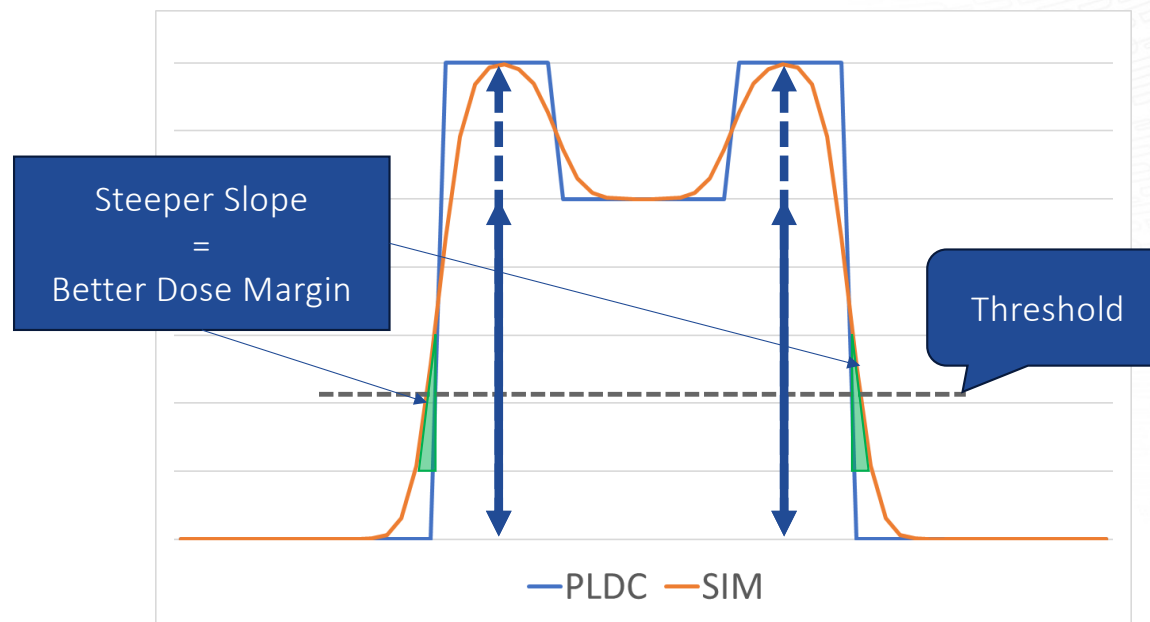
PMJ 2025 by Micron



Paris Spinelli, Nagesh Shirali, Kenichi Yasui, et al. "Full reticle curvilinear inline linearity correction including variable bias with zero turnaround time", Proc. SPIE 13427, Novel Patterning Technologies 2025, 1342705 (6 May 2025); <https://doi.org/10.1117/12.3051087>

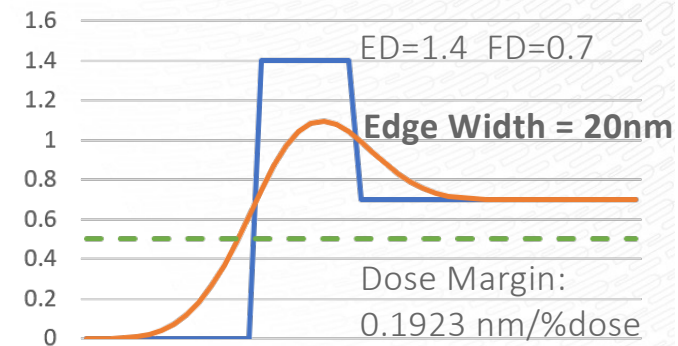
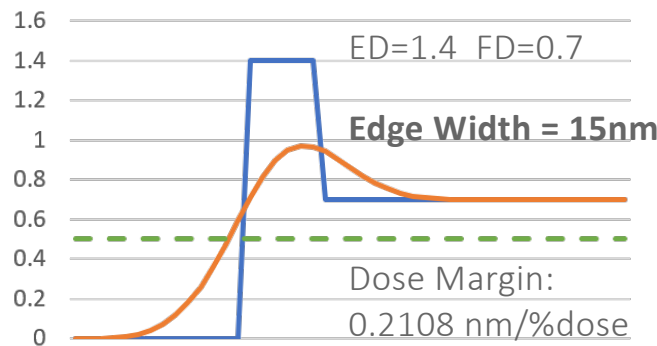
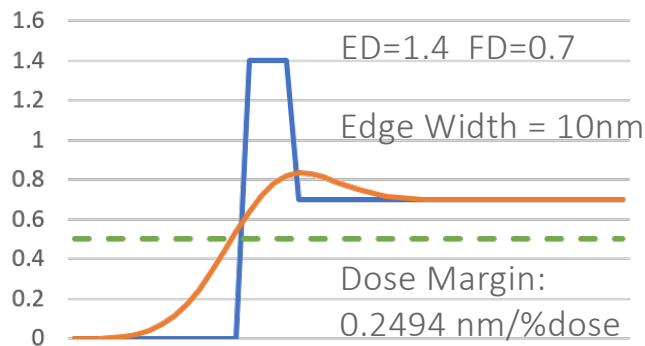
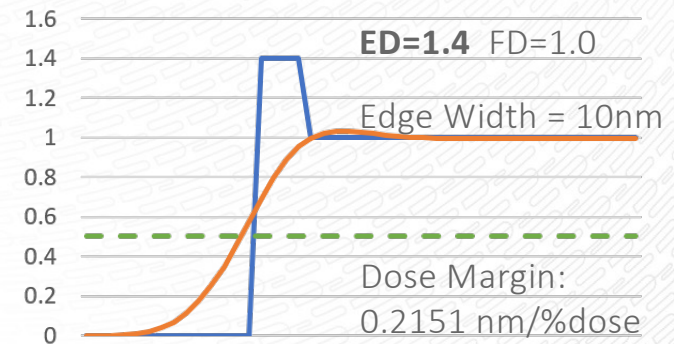
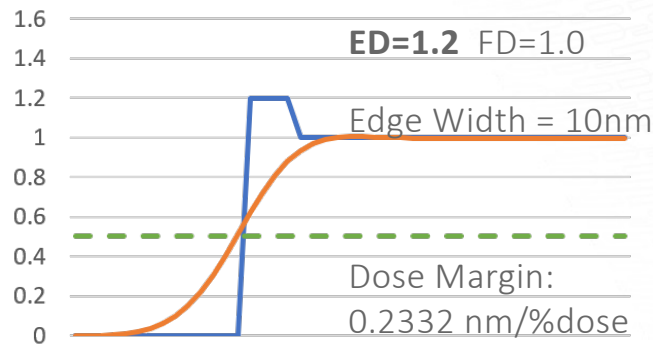
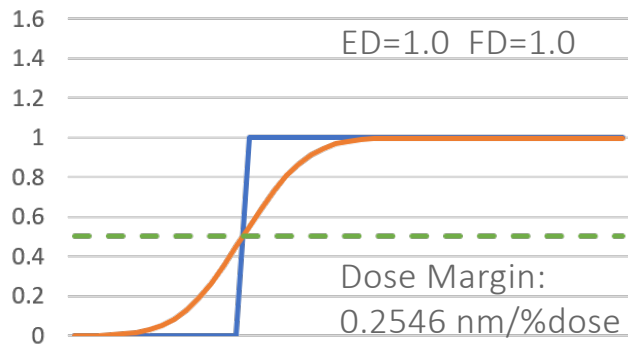
Edge Enhancement Improves Mask Uniformity

Achieved by improving dose margin



D₂S

The Edge Enhancement Height and Width Governs Dose Margin For Short Range Effects

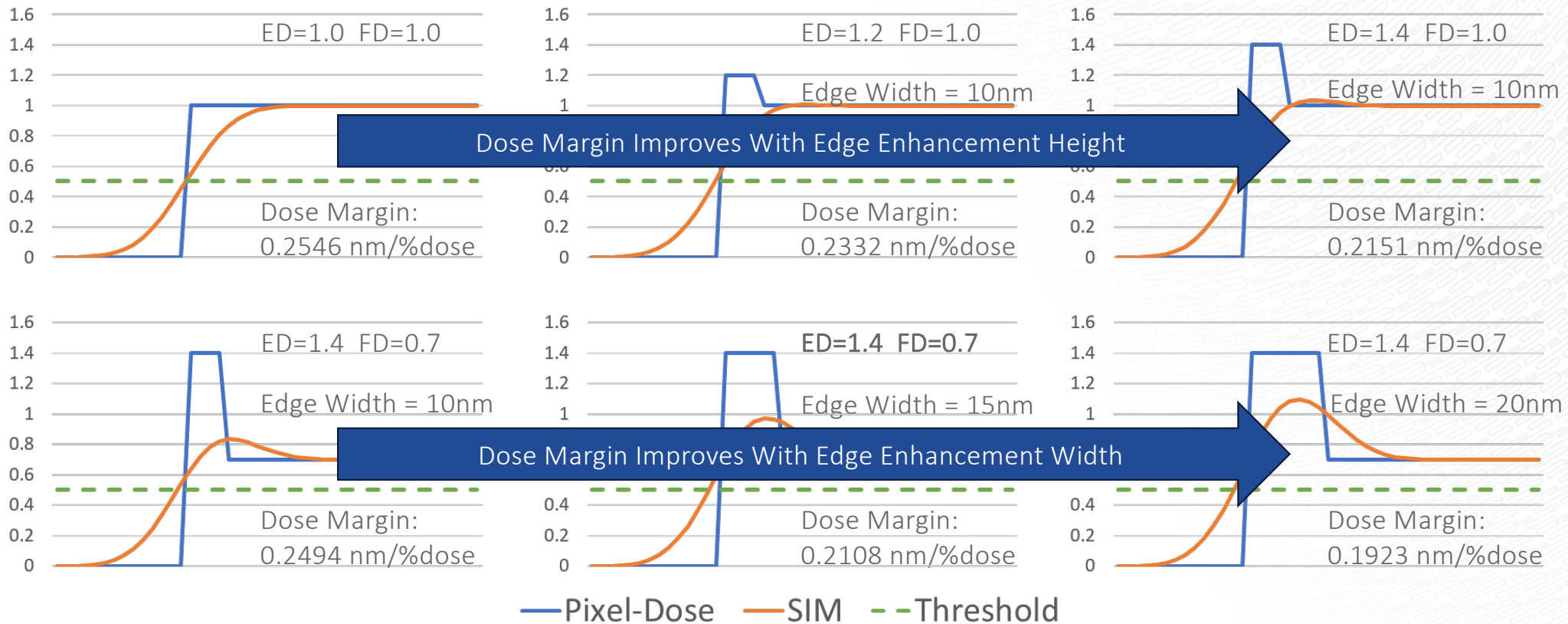


ED : Edge Dose FD : Fill Dose

— Pixel-Dose — SIM - - Threshold

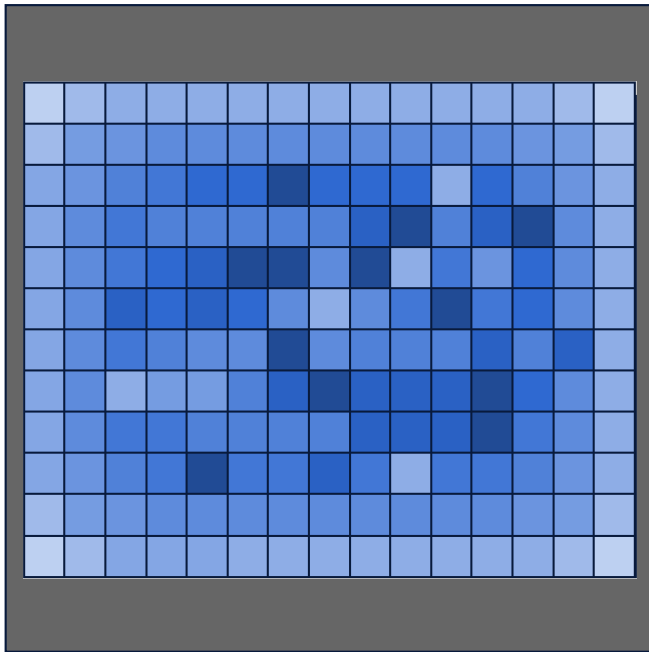


The Edge Enhancement Height and Width Governs Dose Margin For Short Range Effects

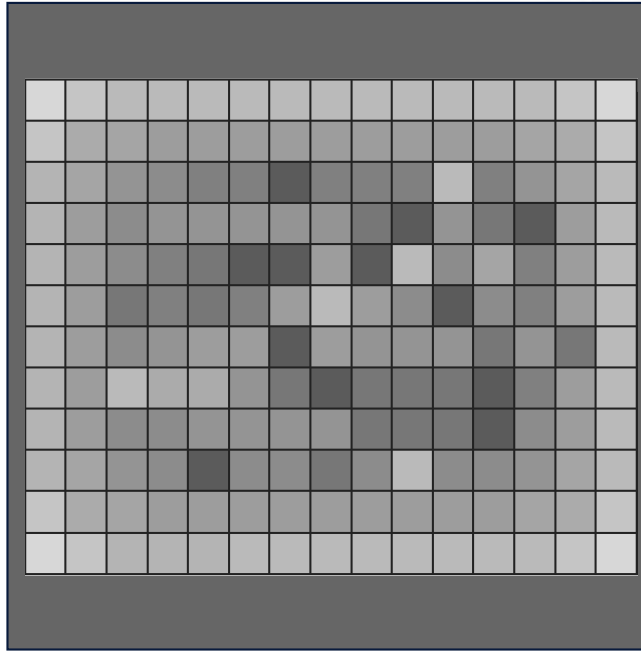


High Pattern Density Regions Have Bad Dose Margin

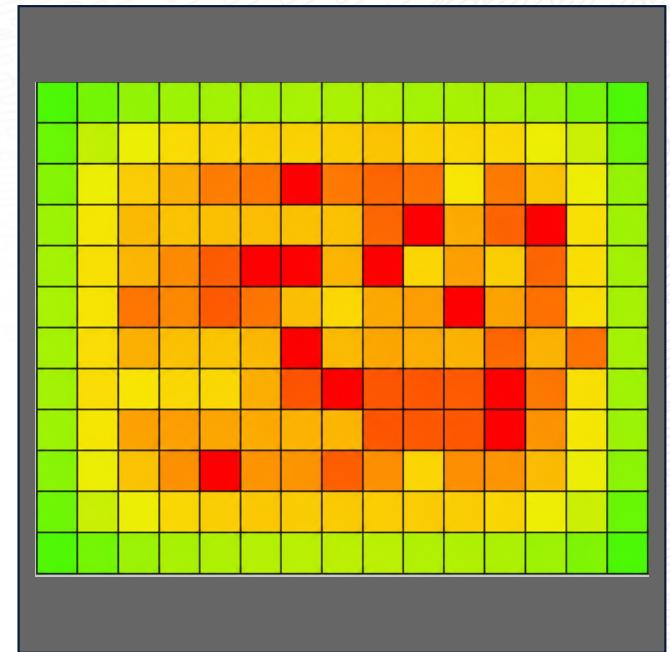
Pattern density



Injected Dose



Dose Margin

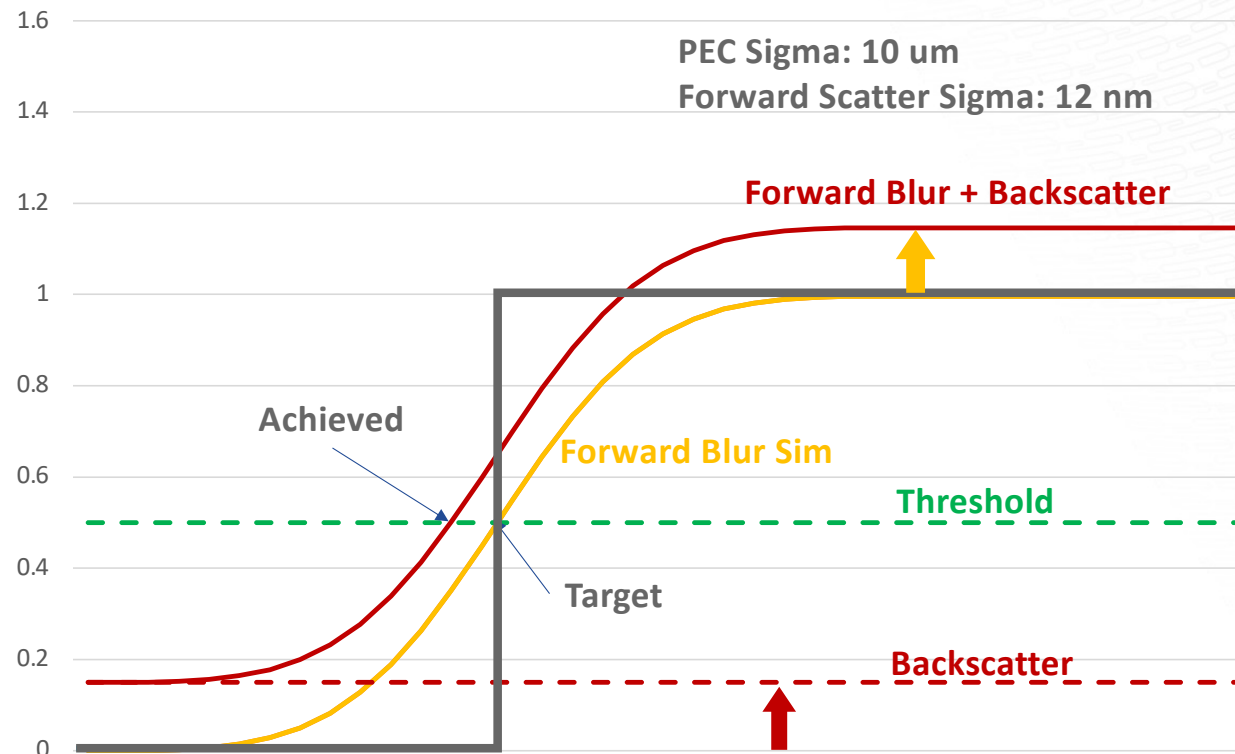


Low dose density
High dose density

High Injected dose
Low Injected dose

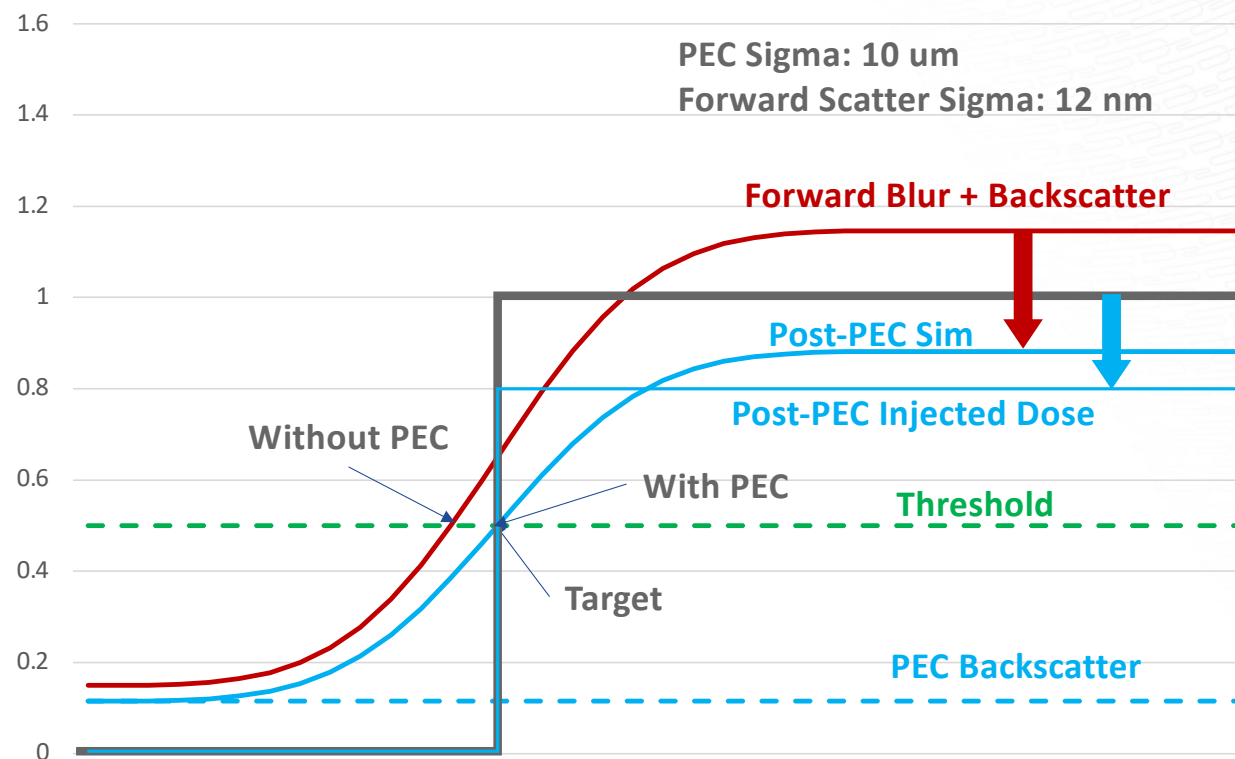
Good Dose Margin
Bad Dose Margin

PEC Involves Correcting For Backscatter



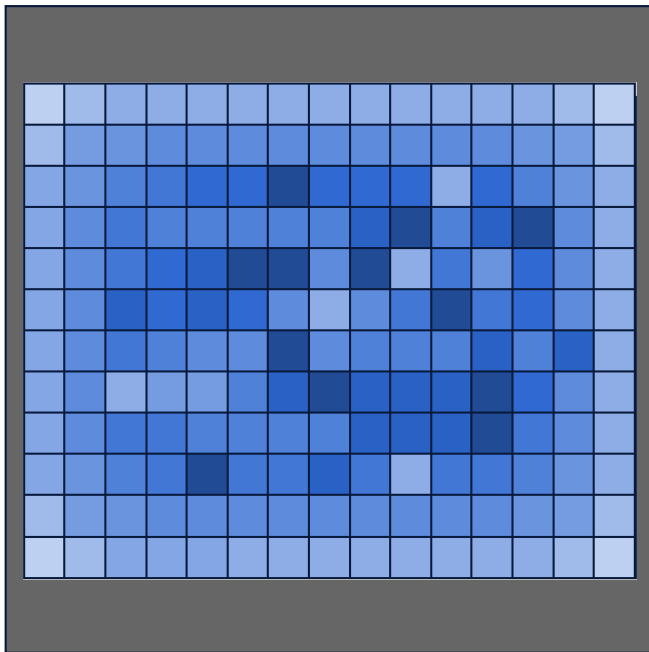
D2S

PEC Reduces The Injected Dose

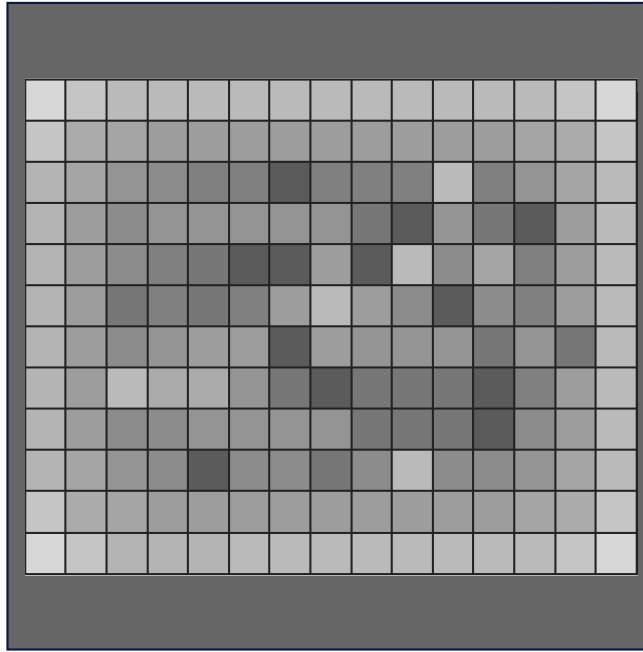


Smaller Injected Dose Produces Bad Dose Margin

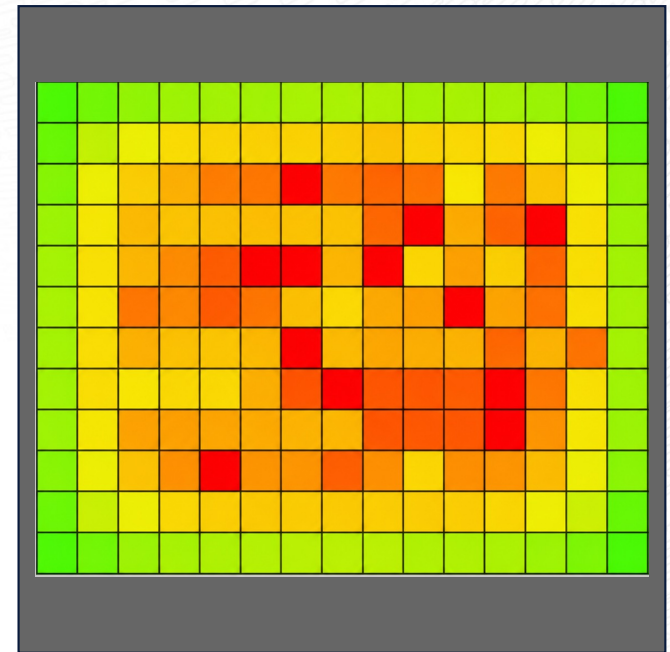
Pattern density



Injected Dose



Dose Margin



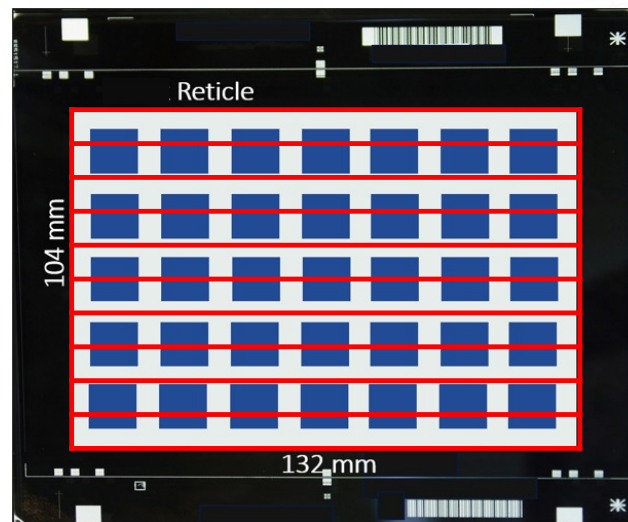
Low dose density
High dose density

High Injected dose
Low Injected dose

Good Dose Margin
Bad Dose Margin

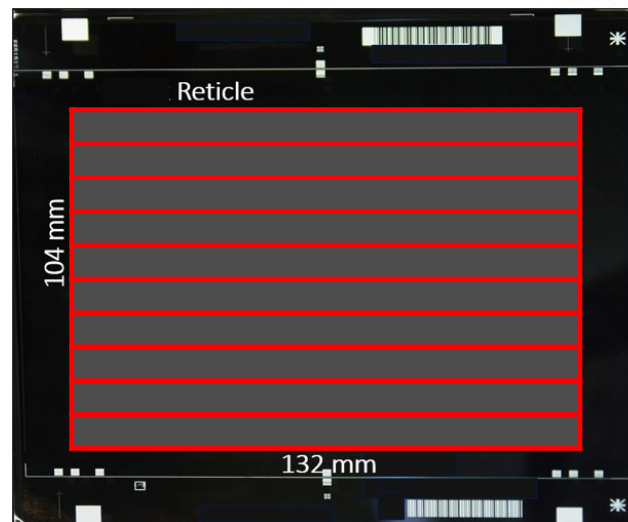
Masks are Written in Stripes with Constant Stage Speed

Stage speed depends on the pattern density



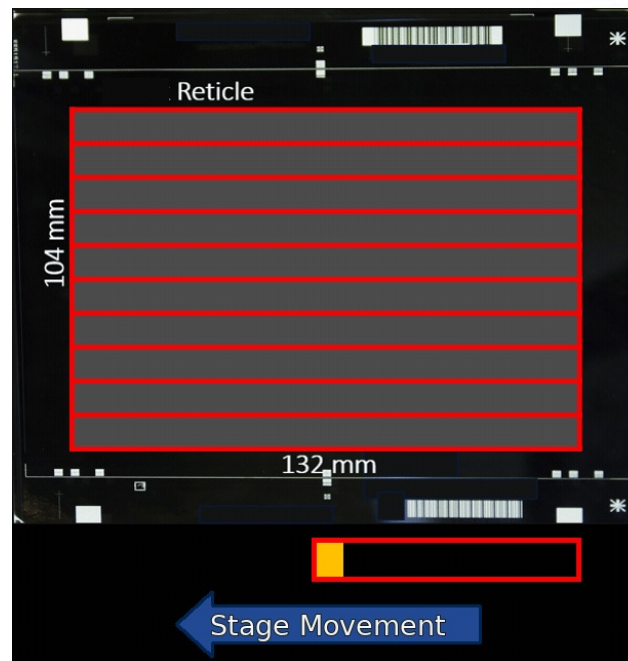
Masks are Written in Stripes with Constant Stage Speed

Stage speed depends on the pattern density



Masks are Written in Stripes with Constant Stage Speed

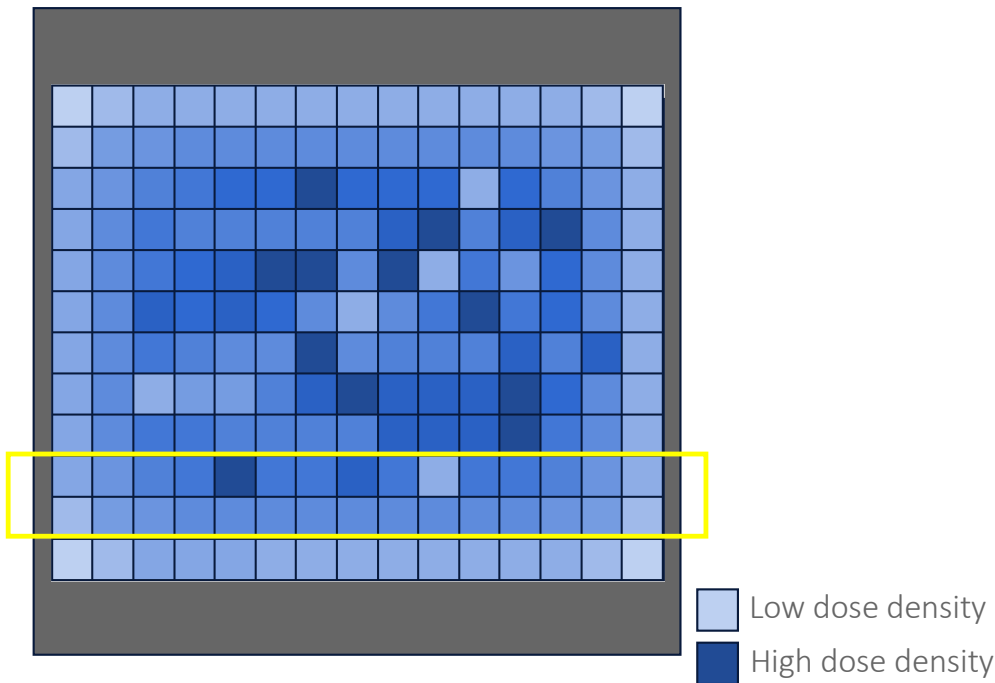
Stage speed depends on the pattern density



D2S

Masks are Written in Stripes with Constant Stage Speed

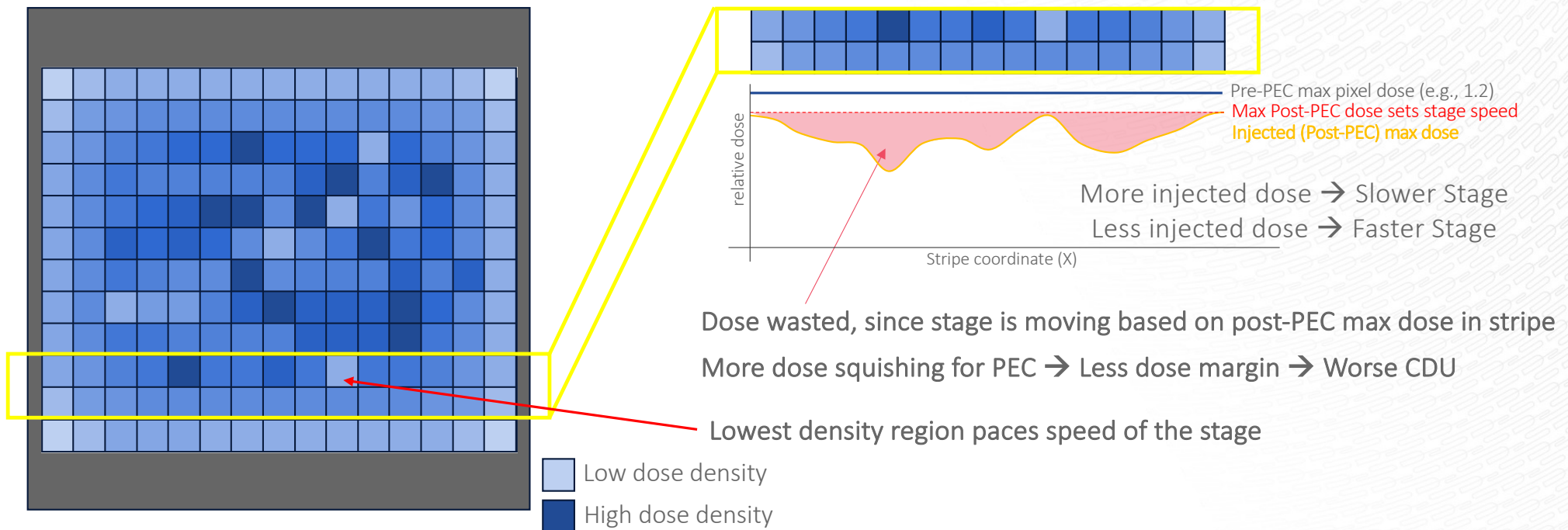
Stage speed depends on the pattern density



Low dose density in PEC neighborhood means higher post-PEC dose cast (see later slide)

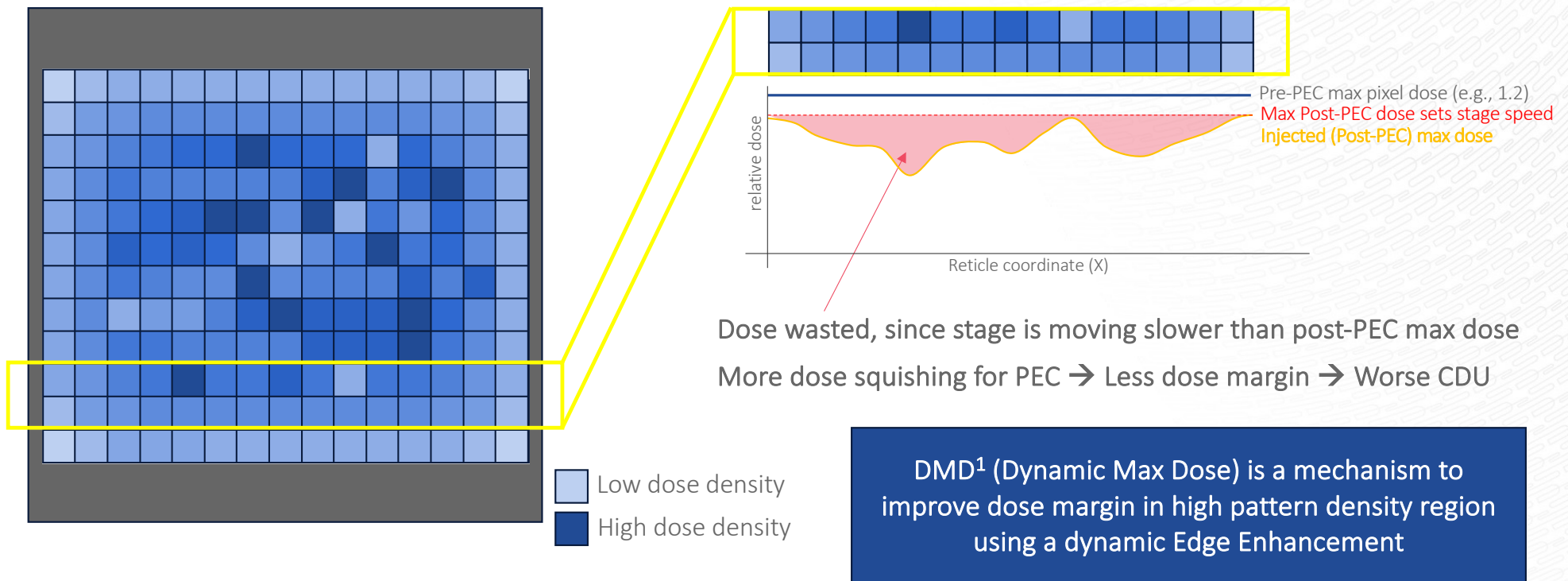


Stage Speed is Set by The Max Injected Dose



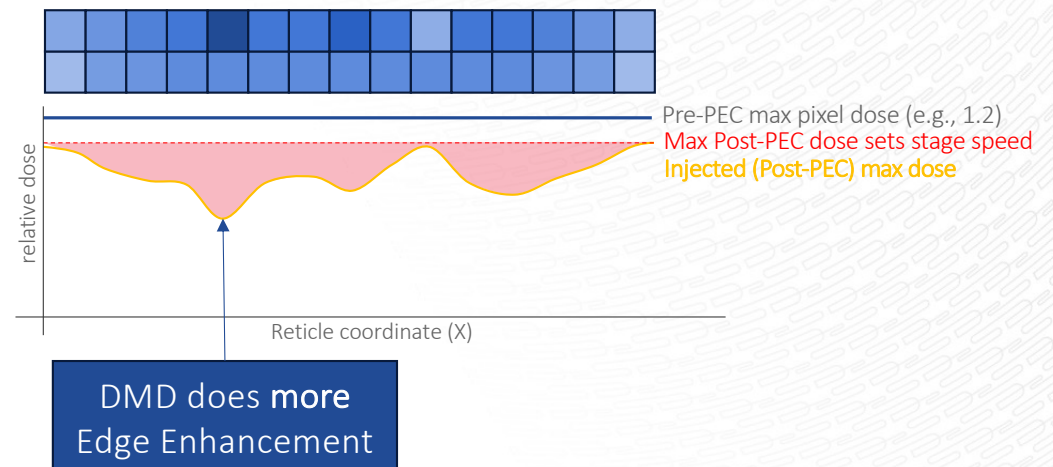
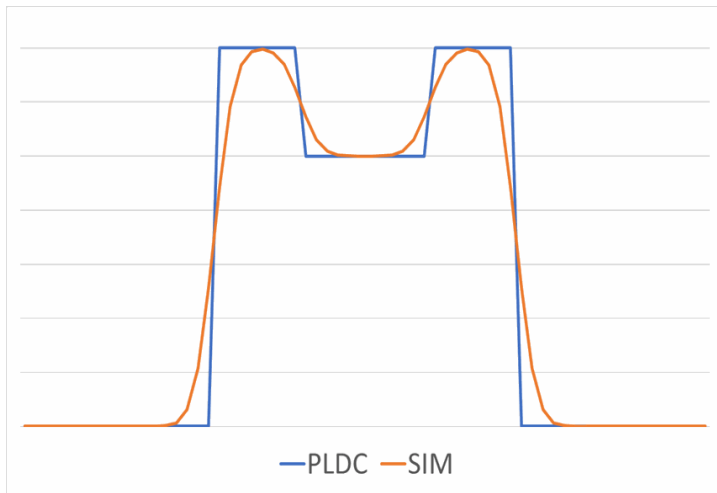
Stage Speed is Set by The Max Injected Dose

DMD uses the “wasted time” to improve LCDU in dense regions



Stage Speed is Set by The Max Injected Dose

DMD uses the “wasted time” to improve LCDU in dense regions



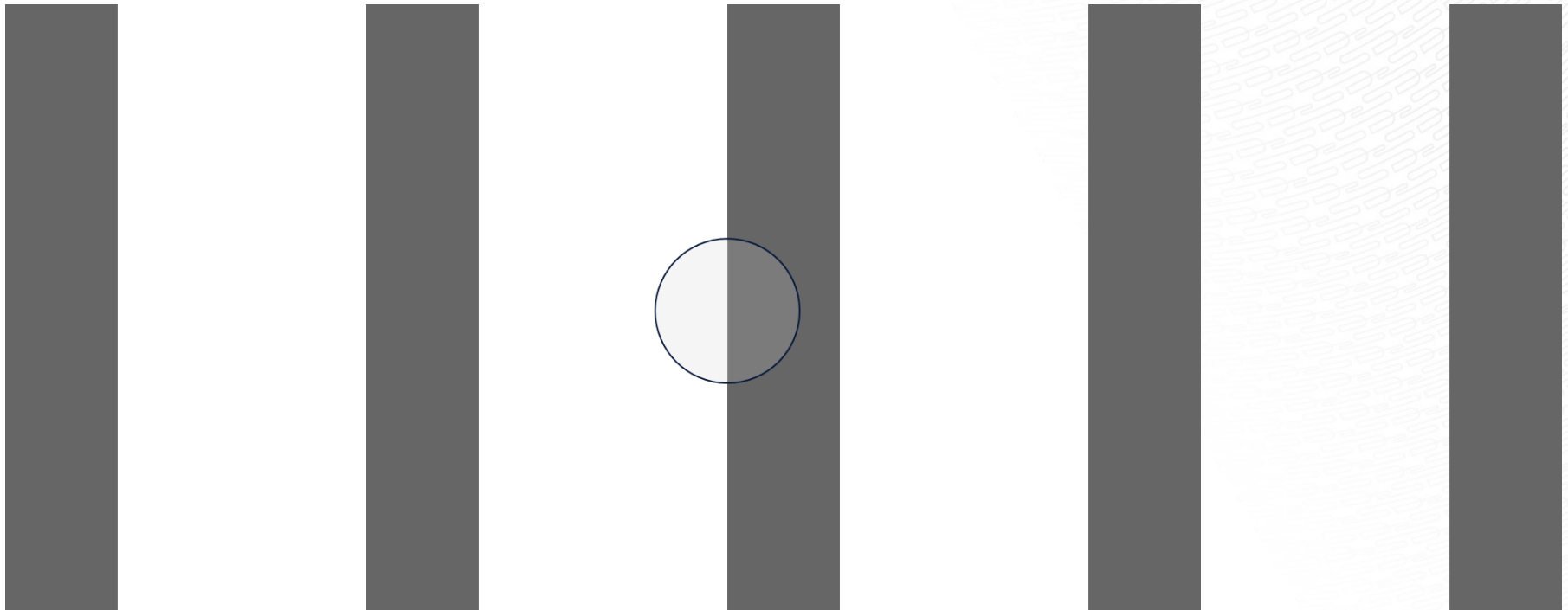
DMD¹ (Dynamic Max Dose) is a mechanism to improve dose margin in high pattern density region using a dynamic Edge Enhancement

Dose Margin is Affected by PEC Correction

Line Space Pattern: Density = 30% Line Width 100nm

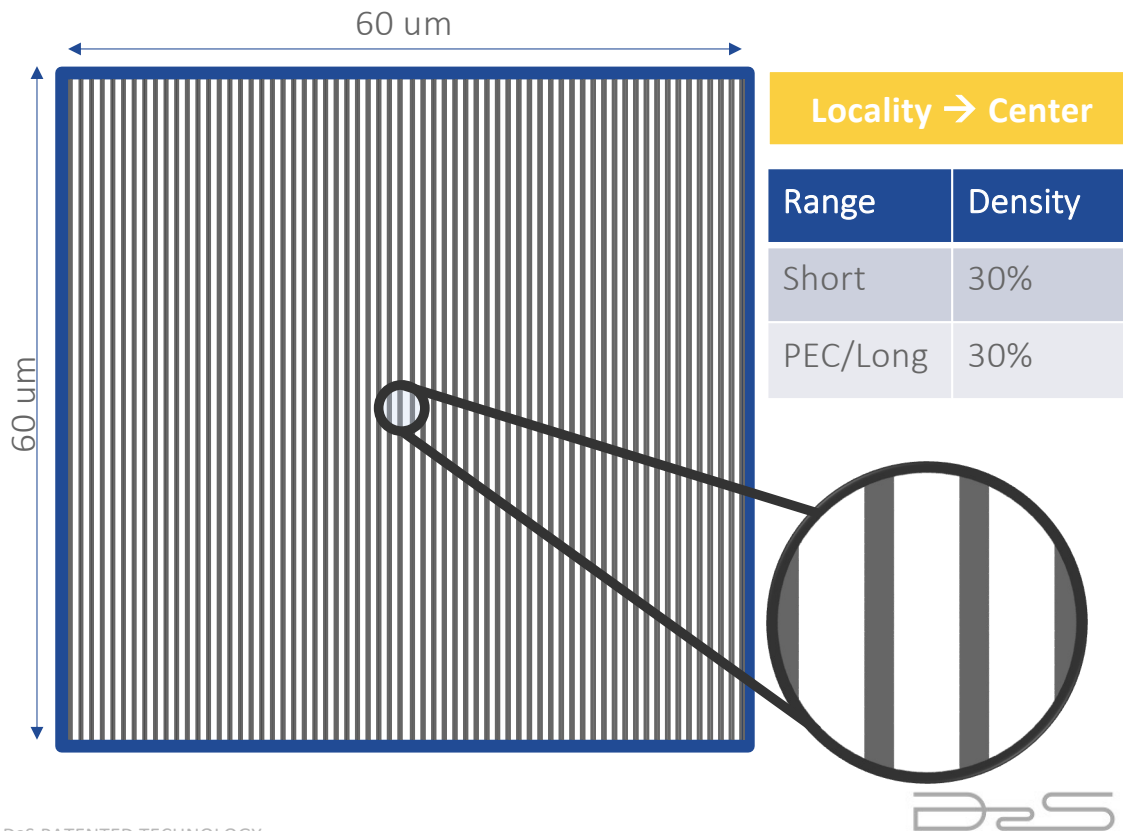
PEC Sigma: 10 μm

Short Range Sigma: 12 nm

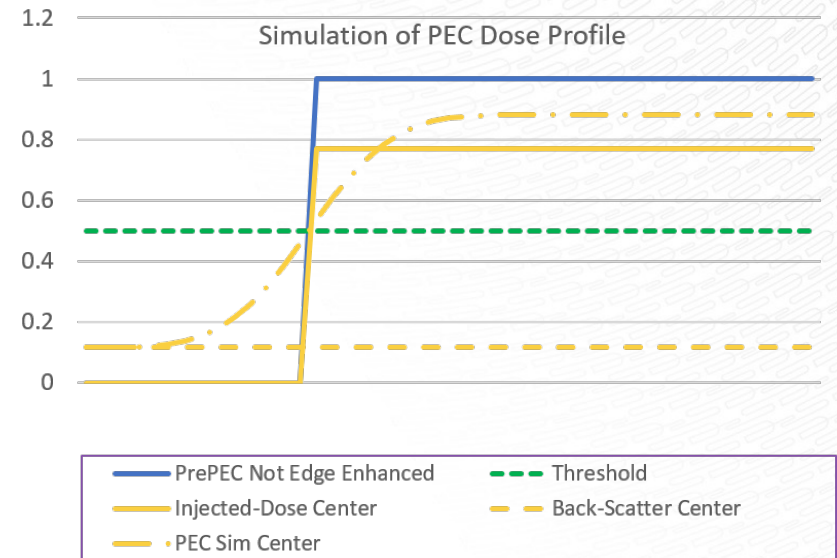


PEC Range Density Varies Depending on the Locality

PEC squishes the injected dose accordingly



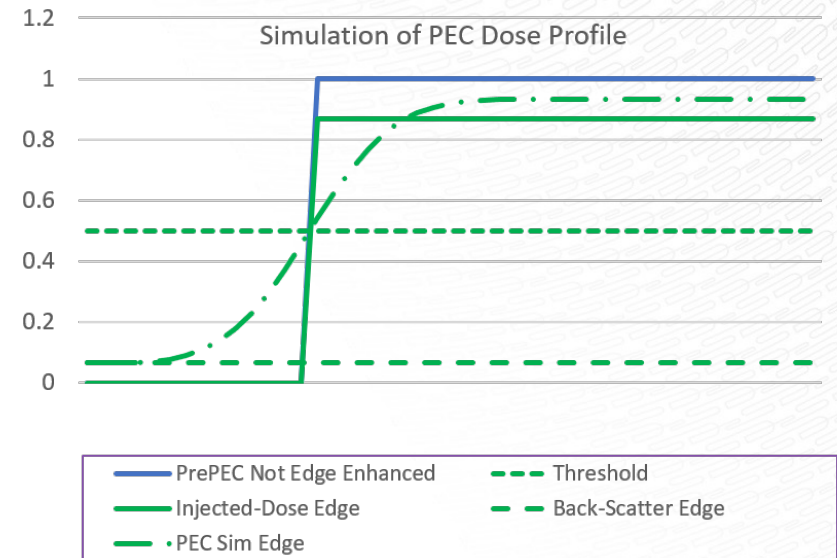
PEC Sigma: 10 um
Short Range Sigma: 12 nm



PEC Range Density Varies Depending on the Locality PEC squishes the injected dose accordingly

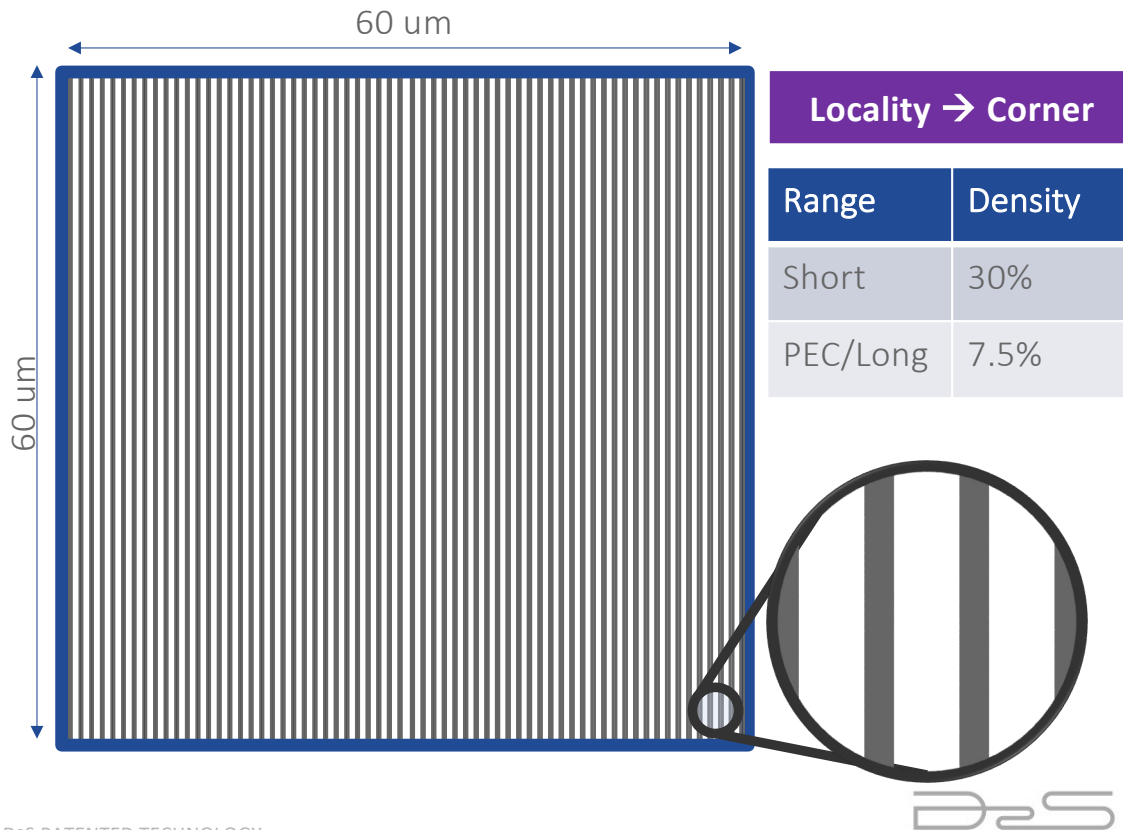


PEC Sigma: 10 um
Short Range Sigma: 12 nm

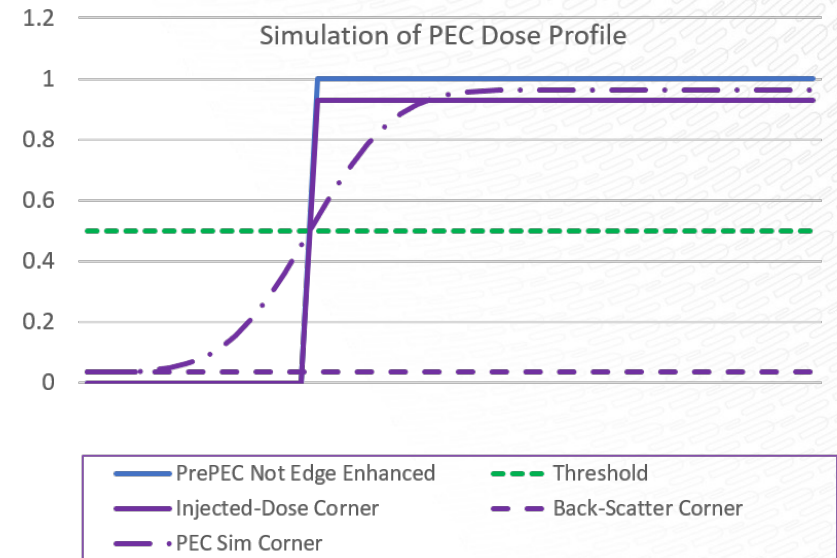


PEC Range Density Varies Depending on the Locality

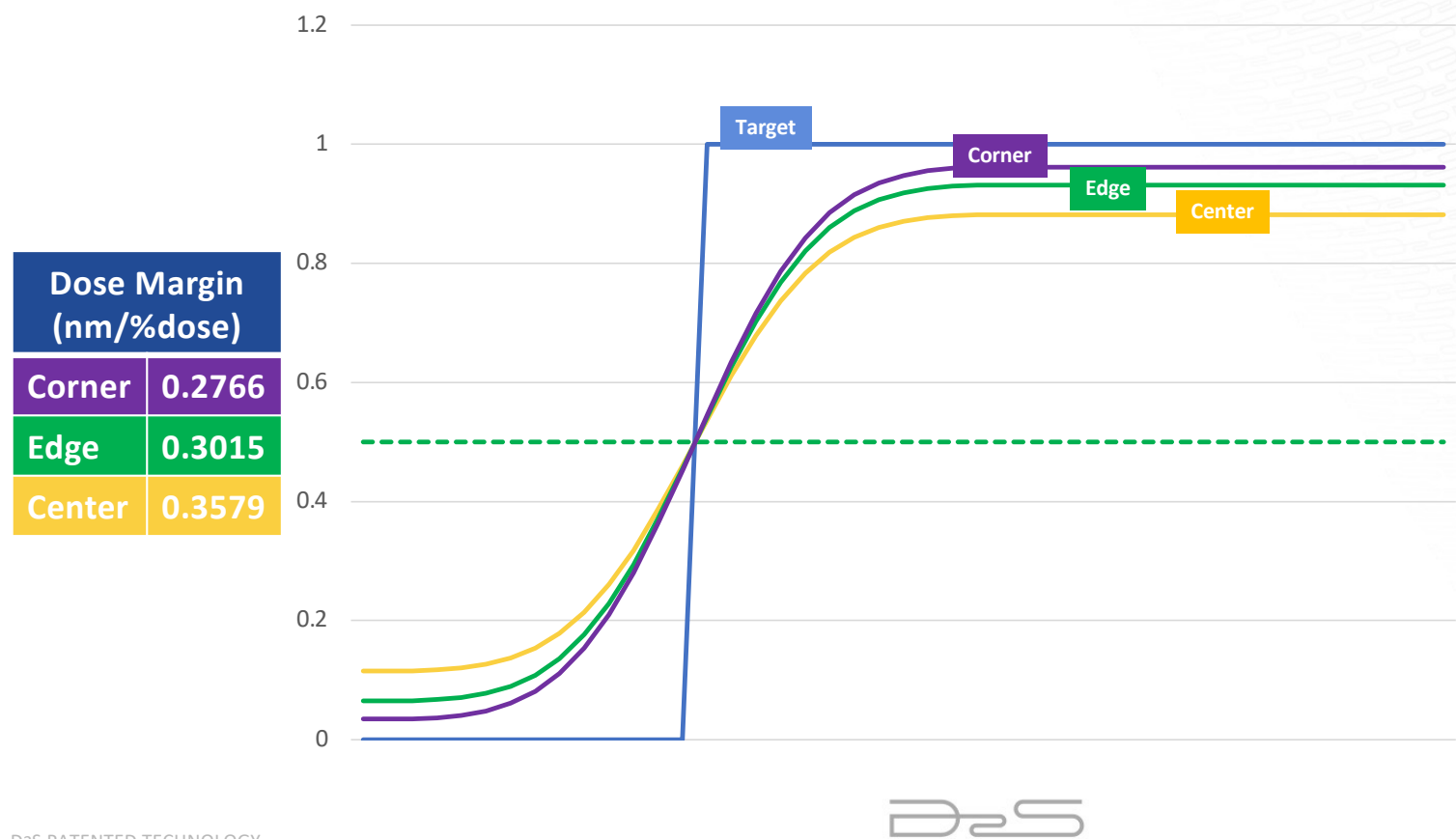
PEC squishes the injected dose accordingly



PEC Sigma: 10 um
Short Range Sigma: 12 nm



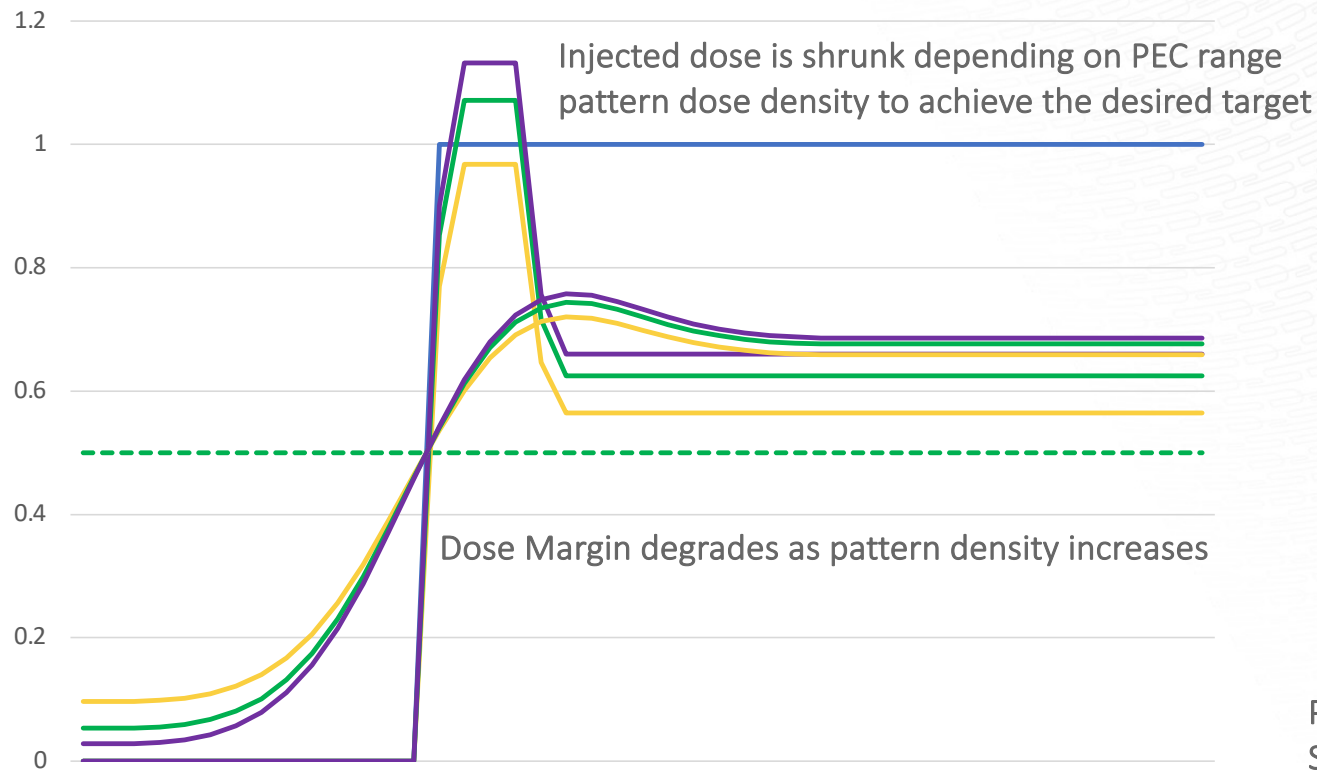
Dose Margin Degrades As Pattern Density Increases



PEC Sigma: 10 um
Short Range Sigma: 12 nm

The Writer Speed is Governed by Max Injected Dose

This provides opportunity to improve dose margin for high density regions



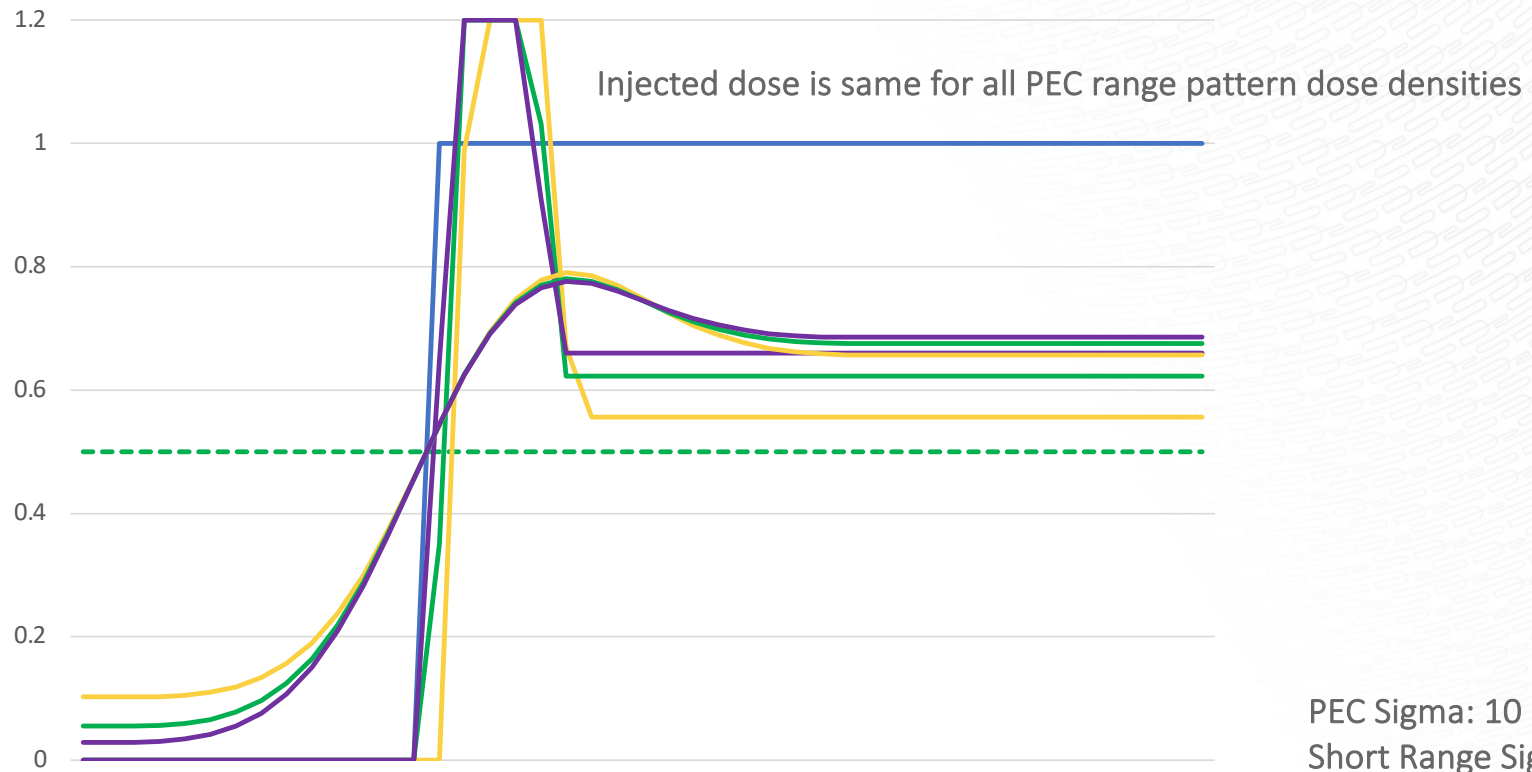
**Dose Margin
(nm/%dose)**

Corner 0.2847

Edge 0.3042

Center 0.3433

Dynamic Max Dose (DMD) Uses This Phenomenon to Improve Dose Margin for High Density Regions



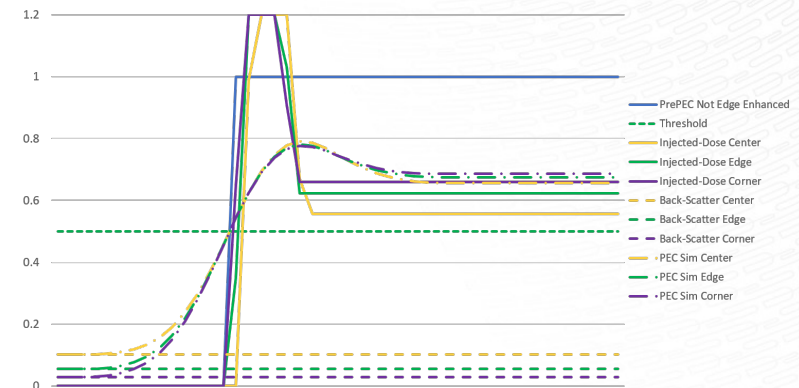
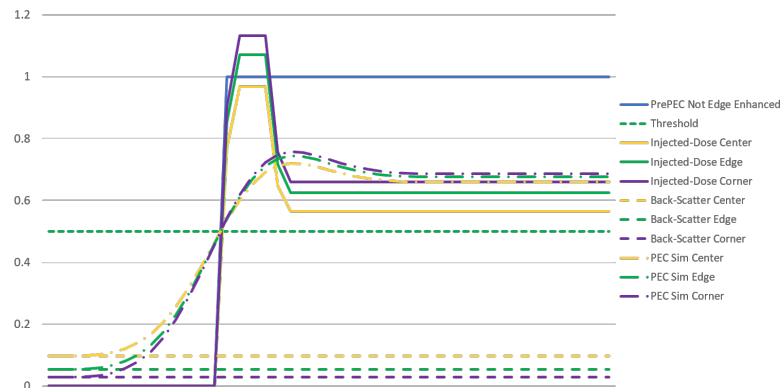
Dose Margin (nm/%dose)	
Corner	0.2764
Edge	0.2856
Center	0.3150

D₂S

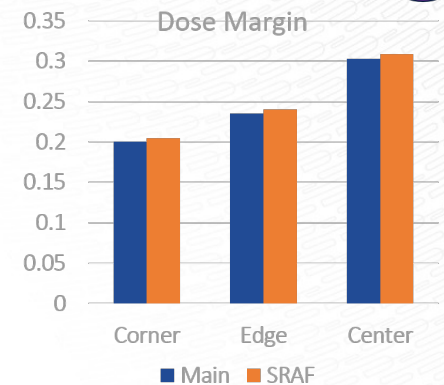
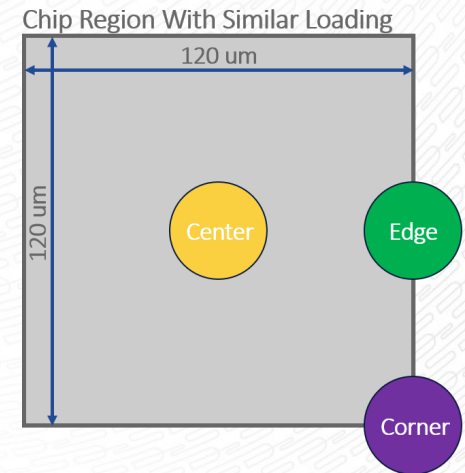
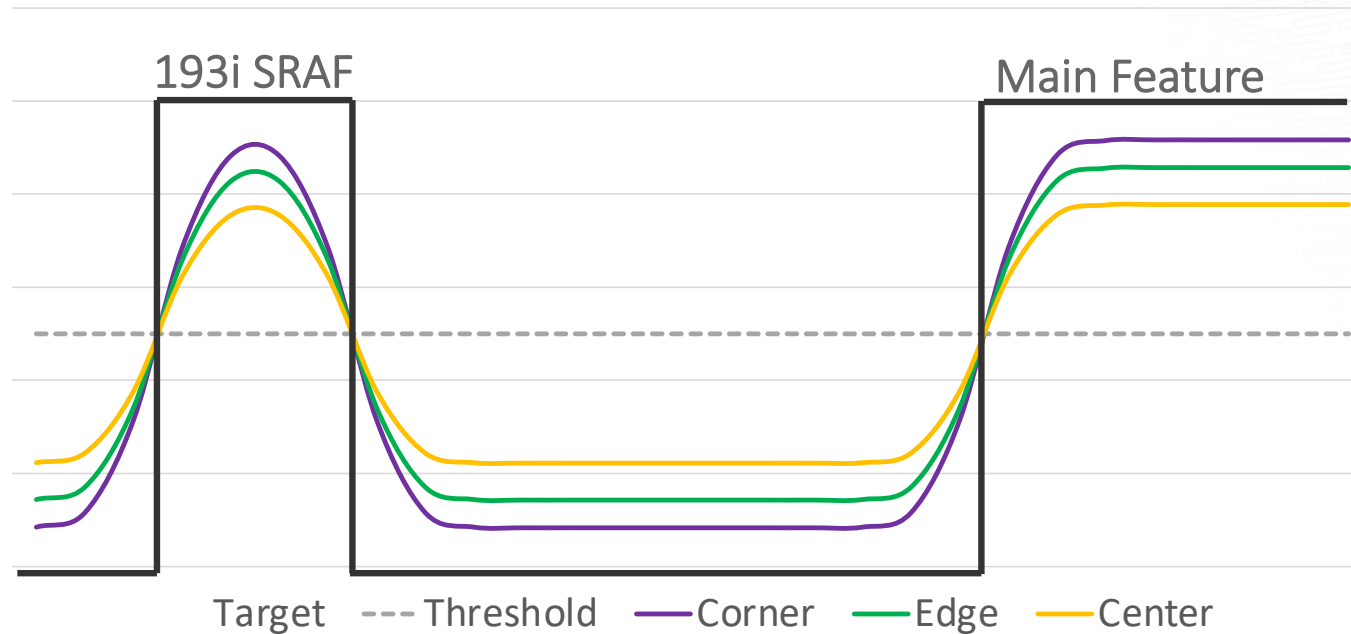
DMD Uniquely Improves Dose Margin Without Affecting Machine Write Time

	Dose Margin (nm/%dose)		Dose Margin Improvement
Mode	Without DMD	With DMD	
Corner	0.2847	0.2764	3%
Edge	0.3042	0.2856	6.5%
Center	0.3433	0.3150	9%
Range	0.0586	0.0386	34%

Larger improvement for high-density regions

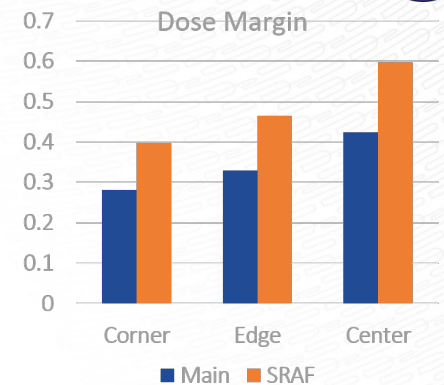
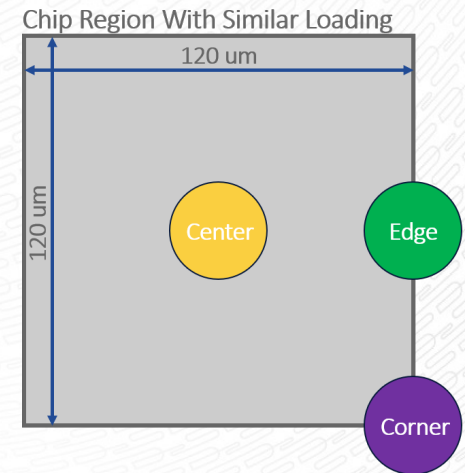
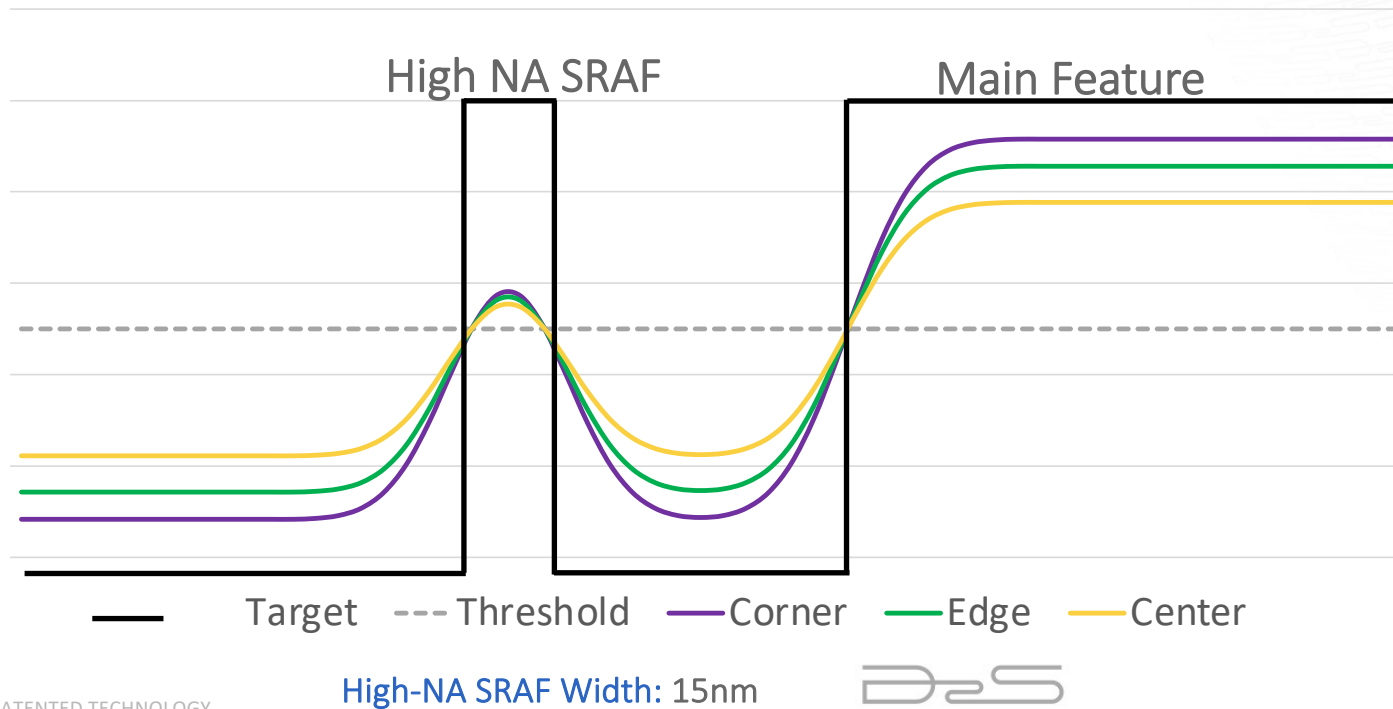


But Geometry Effects like Loading Should be Corrected By Geometric Bias Mechanisms

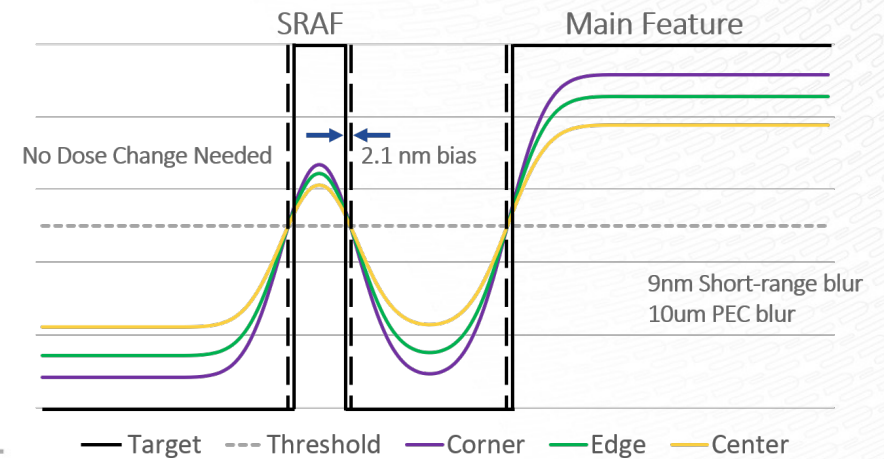
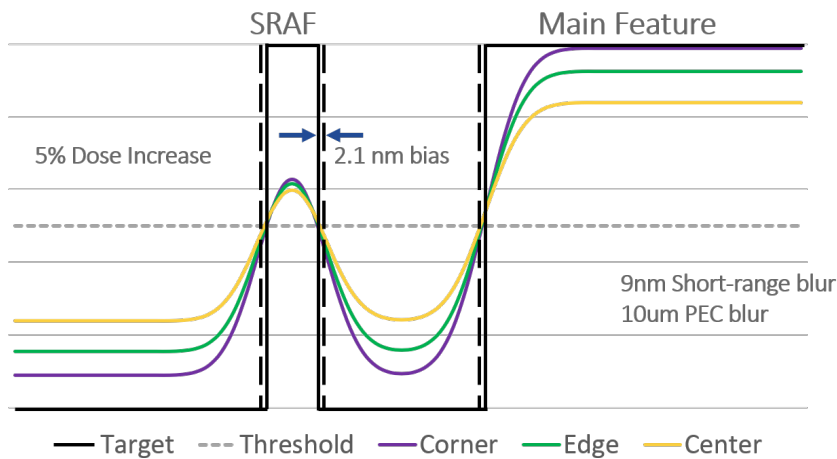
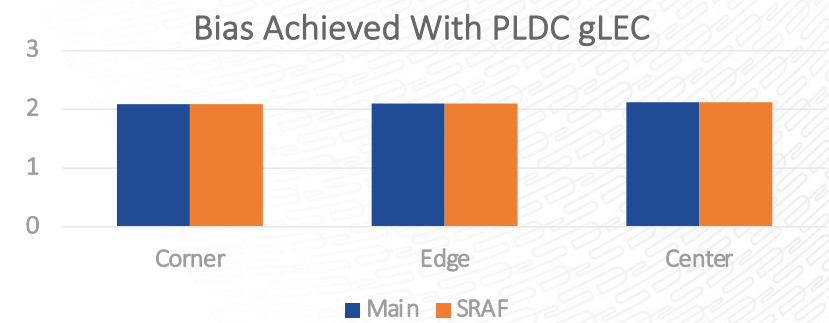
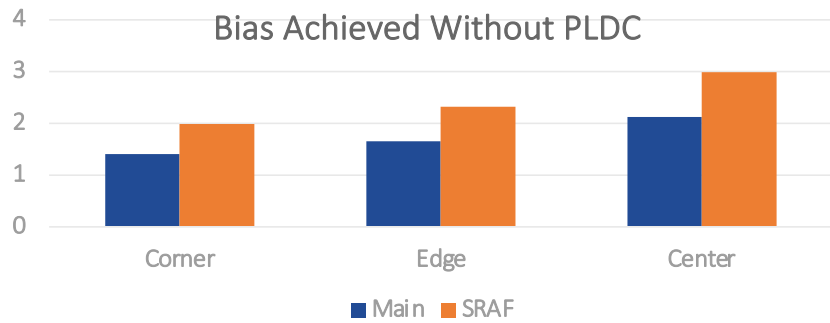


For High-NA, The Dose Margin Variation Is Larger

So, dose-based methods will be more inaccurate

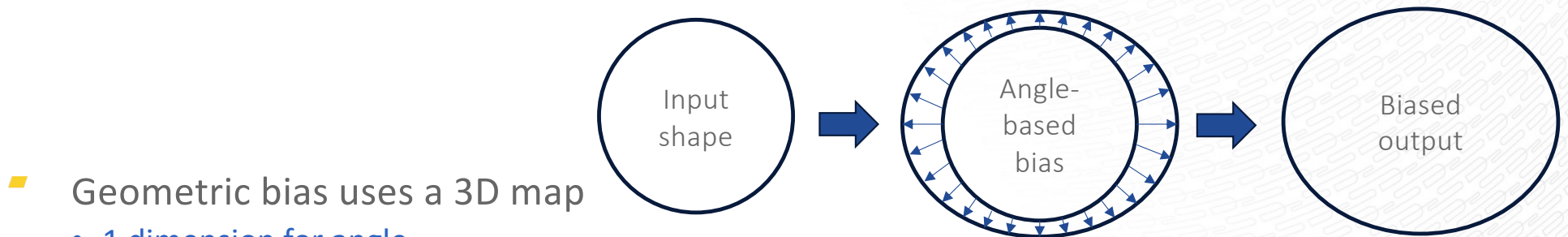


PLDC gLEC Improves CD Uniformity for Geometric Effect



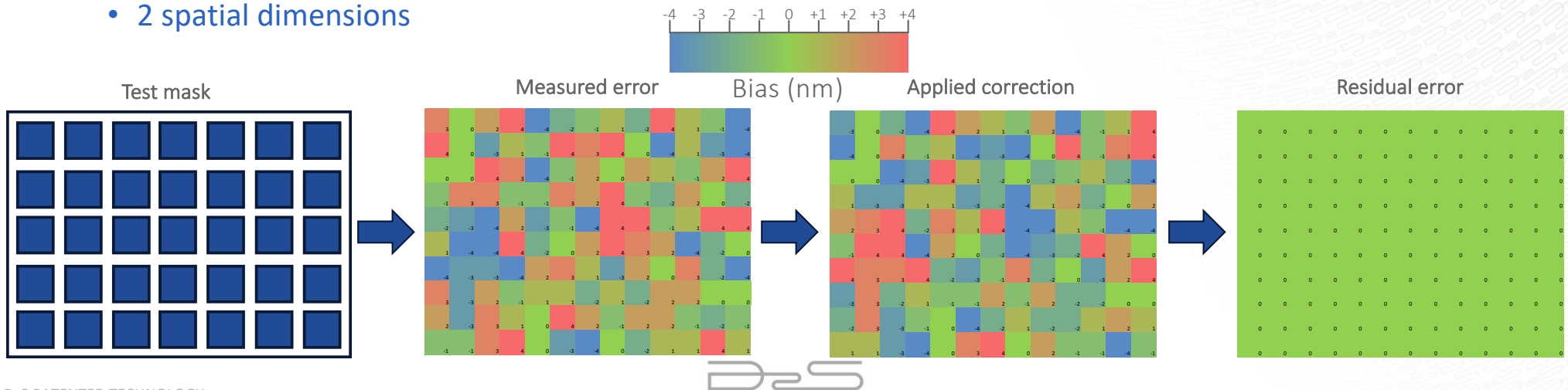
D2S PLDC Has A Regional Radial Bias (RRBias) Correction

gLEC bias is an instance of general geometric bias correction i.e. RRBias



Geometric bias uses a 3D map

- 1 dimension for angle
- 2 spatial dimensions

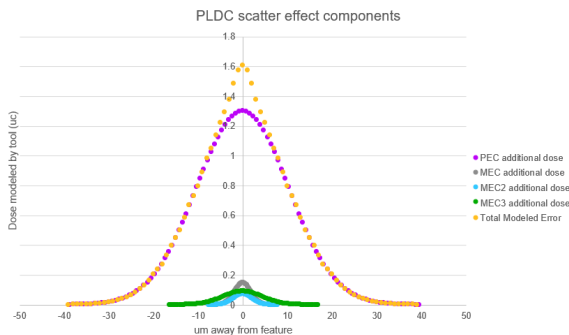
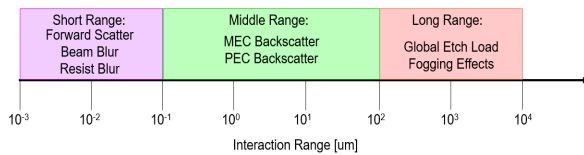


With D2S PLDC

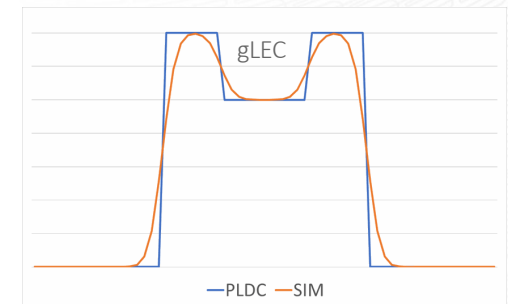
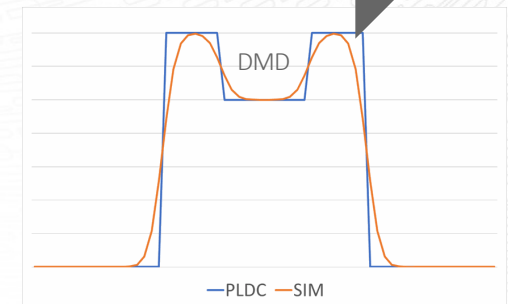
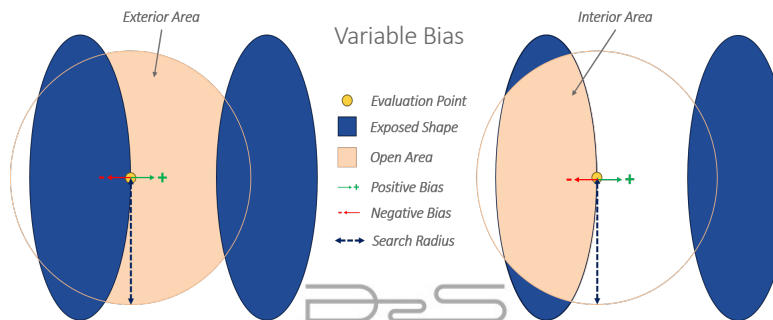
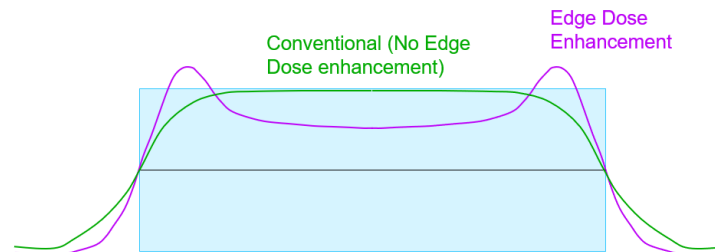
Geometric Effects are Corrected using Geometric Bias

Dose Effects are Corrected using Dose Bias

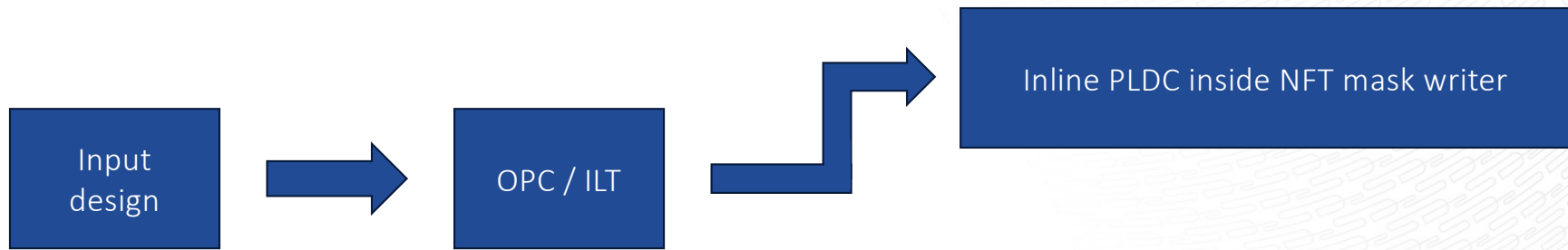
Beam Blur + Edge Dose Enhancement + Dynamic Max Dose + Variable Bias + gLEC / RRBias



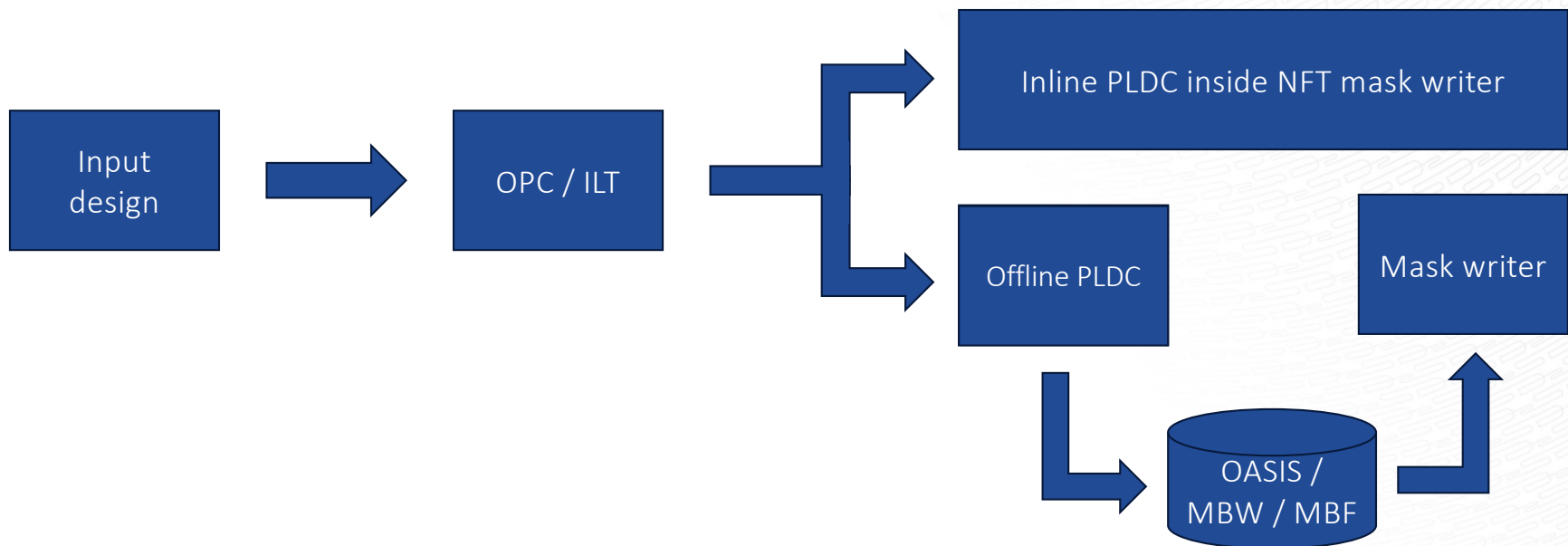
Multi-gaussian Model Based Blur Correction



D2S PLDC is Available Inline To Enhance Mask Uniformity and Linearity



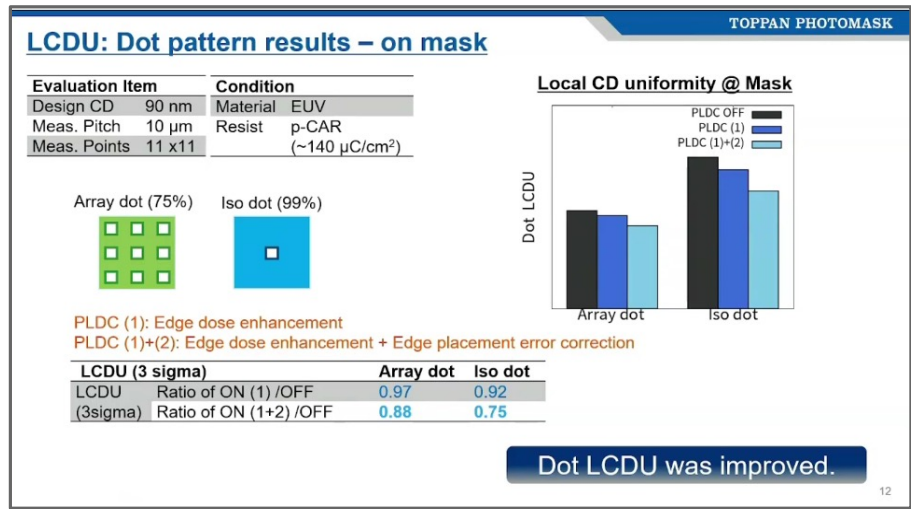
D2S PLDC is Available Inline or Offline To Enhance Mask Uniformity and Linearity



DMD and gLEC with RRBias Improve Mask Uniformity With No Impact On Mask Write Time

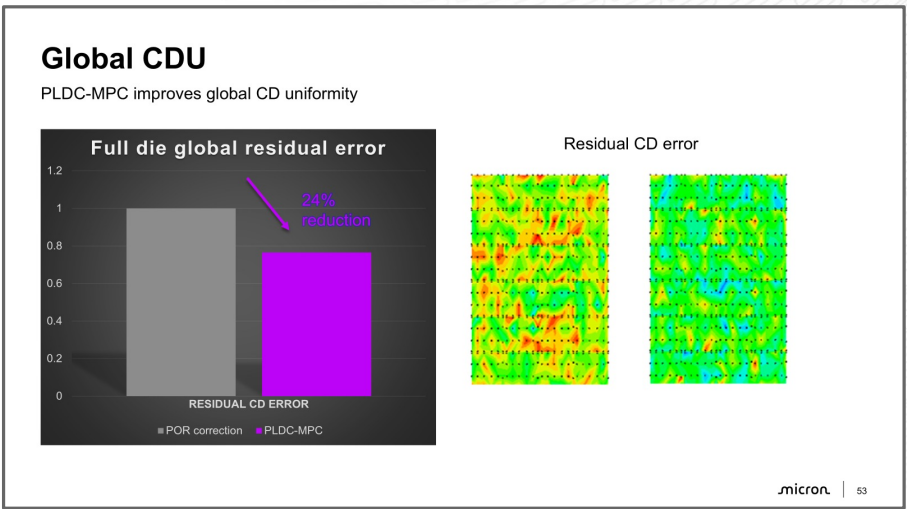
Every variation on mask is a systematic variation on wafer
PLDC improves mask uniformity and thereby wafer CDU

BACUS 2024 by Tekscend



Mayuko Matsumoto, Naoki Yoshida, Tetsunori Hirata, et al. "Mask performance improvement by pixel level dose correction", Proc. SPIE 13216, Photomask Technology 2024, 132160H (12 Nov 2024); <https://doi.org/10.1117/12.3034611>

PMJ 2025 by Micron



Paris Spinelli, Nagesh Shirali, Kenichi Yasui, et al. "Full reticle curvilinear inline linearity correction including variable bias with zero turnaround time", Proc. SPIE 13427, Novel Patterning Technologies 2025, 1342705 (6 May 2025); <https://doi.org/10.1117/12.3051087>

DES